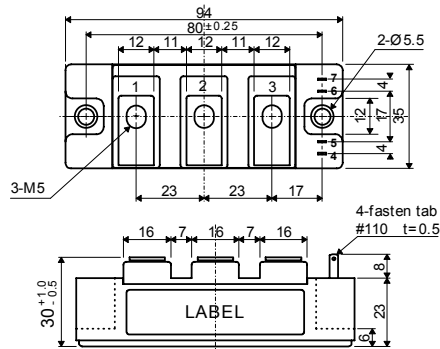
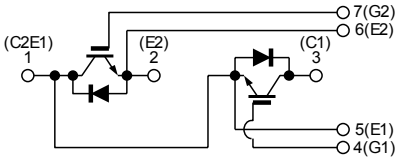


□ 回路図 : *CIRCUIT*

□ 外形寸法図 : *OUTLINE DRAWING*



Dimension: [mm]

□ 最大定格 : *MAXIMUM RATINGS* ( $T_c=25^\circ\text{C}$ )

Item	Symbol	Rated Value	Unit
コレクタ・エミッタ間電圧 Collector-Emitter Voltage	$V_{CES}$	1,200	V
ゲート・エミッタ間電圧 Gate-Emitter Voltage	$V_{GES}$	±20	V
コレクタ電流 Collector Current	DC	50	A
	1ms	100	
コレクタ損失 Collector Power Dissipation	$P_C$	250	W
接合温度 Junction Temperature Range	$T_j$	-40~+150	°C
保存温度 Storage Temperature Range	$T_{stg}$	-40~+125	°C
絶縁耐圧(Terminal to Base AC, 1 minute) Isolation Voltage	$V_{ISO}$	2,500	V <sub>(RMS)</sub>
締め付けトルク Mounting Torque	Module Base to Heatsink	2 (20.4)	N·m (kgf·cm)
	Busbar to Main Terminal		

□ 電気的特性 : *ELECTRICAL CHARACTERISTICS* ( $T_c=25^\circ\text{C}$ )

Characteristic	Symbol	Test Condition	Min.	Tvp.	Max.	Unit
コレクタ遮断電流 Collector-Emitter Cut-Off Current	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V$	-	-	1.0	mA
ゲート漏れ電流 Gate-Emitter Leakage Current	$I_{GES}$	$V_{GE}=\pm 20V, V_{CE}=0V$	-	-	1.0	μA
コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=50A, V_{GE}=15V$	-	1.9	2.4	V
ゲートしきい値電圧 Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE}=5V, I_C=50mA$	4.0	-	8.0	V
入力容量 Input Capacitance	$C_{ies}$	$V_{CE}=10V, V_{GE}=0V, f=1MHz$	-	4,200	-	pF
スイッチング時間 Switching Time	上昇時間 Rise Time	$V_{CC}=600V$ $R_L=12\Omega$ $R_G=20\Omega$ $V_{GE}=\pm 15V$	-	0.25	0.45	μs
	ターンオン時間 Turn-on Time		-	0.40	0.70	
	下降時間 Fall Time		-	0.25	0.35	
	ターンオフ時間 Turn-off Time		-	0.80	1.10	

□ フリーホイールダイオードの特性 : *FREE WHEELING DIODE RATINGS & CHARACTERISTICS* ( $T_c=25^\circ\text{C}$ )

Item	Symbol	Rated Value	Unit			
順電流 Forward Current	DC	50	A			
	1ms	100				
Characteristic	Symbol	Test Condition	Min.	Tvp.	Max.	Unit
順電圧 Peak Forward Voltage	$V_F$	$I_F=50A, V_{GE}=0V$	-	1.9	2.4	V
逆回復時間 Reverse Recovery Time	$t_{rr}$	$I_F=50A, V_{GE}=-10V$ $di/dt=100A/\mu s$	-	0.2	0.3	μs

□ 熱的特性 : *THERMAL CHARACTERISTICS*

Characteristic	Symbol	Test Condition	Min.	Tvp.	Max.	Unit
熱抵抗 Thermal Impedance	IGBT	Junction to Case	-	-	0.43	°C/W
	Diode		-	-	0.7	

P D M B 5 0 B 1 2

Fig.1- Output Characteristics (Typical)

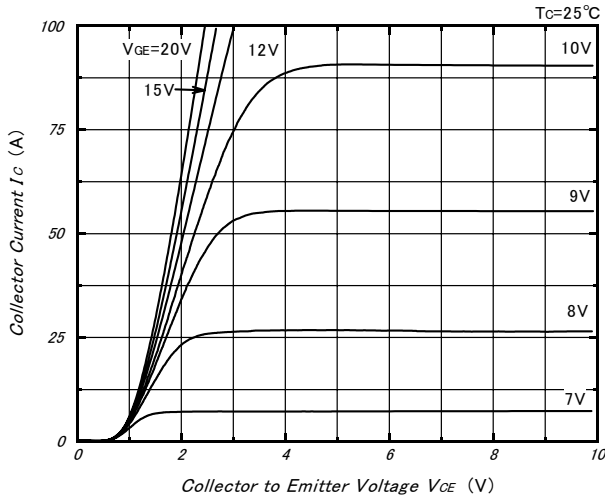


Fig.2- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)

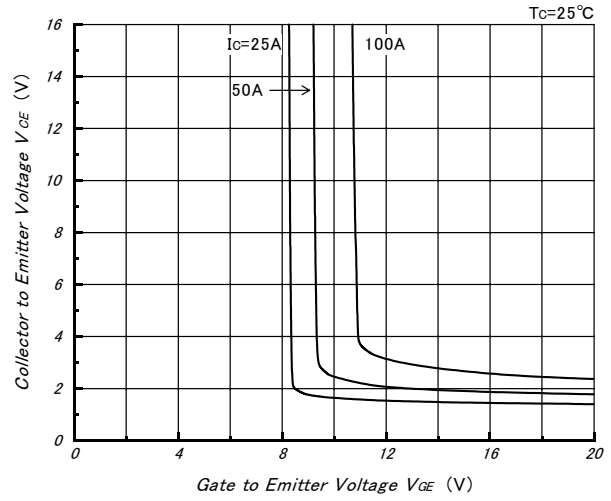


Fig.3- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)

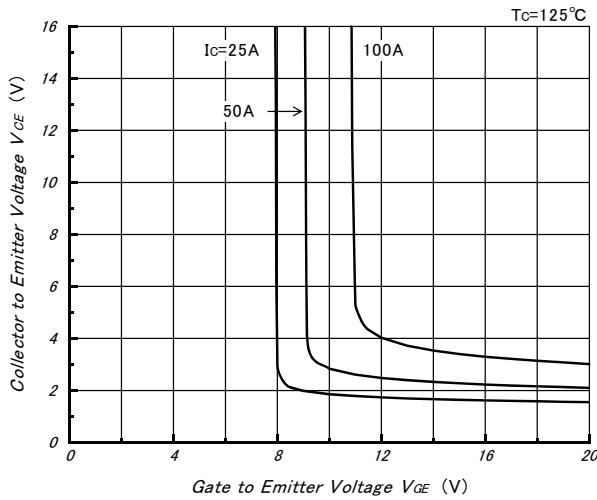


Fig.4- Gate Charge vs. Collector to Emitter Voltage (Typical)

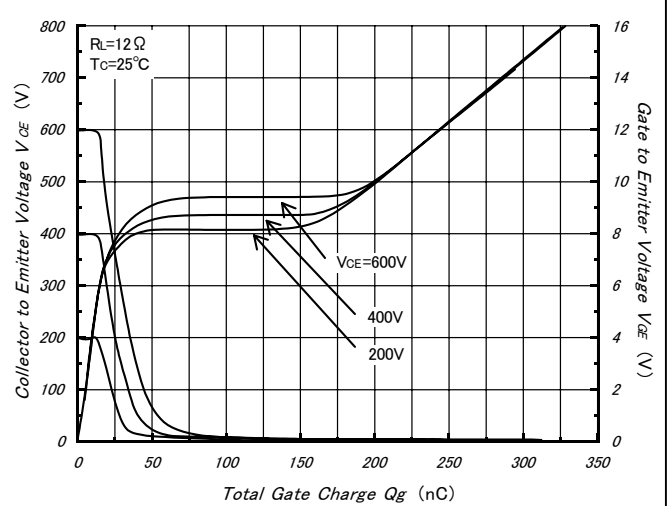


Fig.5- Capacitance vs. Collector to Emitter Voltage (Typical)

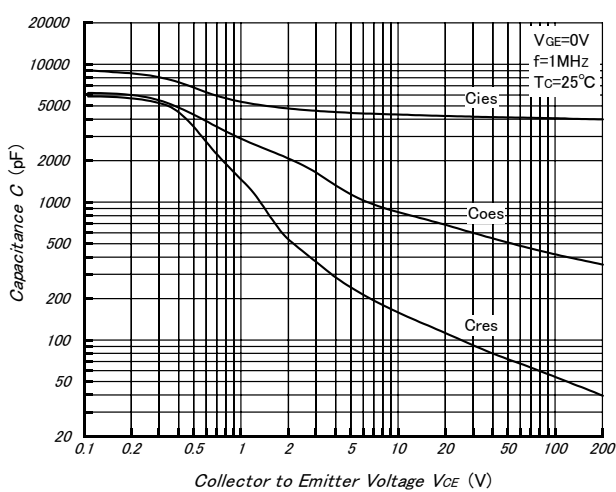
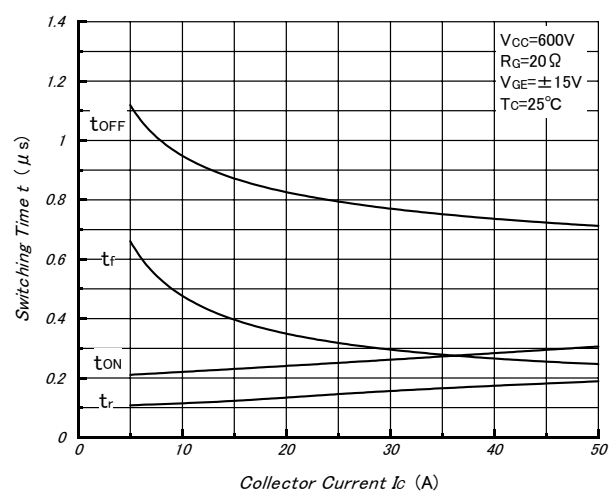


Fig.6- Collector Current vs. Switching Time (Typical)



P D M B 5 0 B 1 2

Fig.7- Series Gate Impedance vs. Switching Time (Typical)

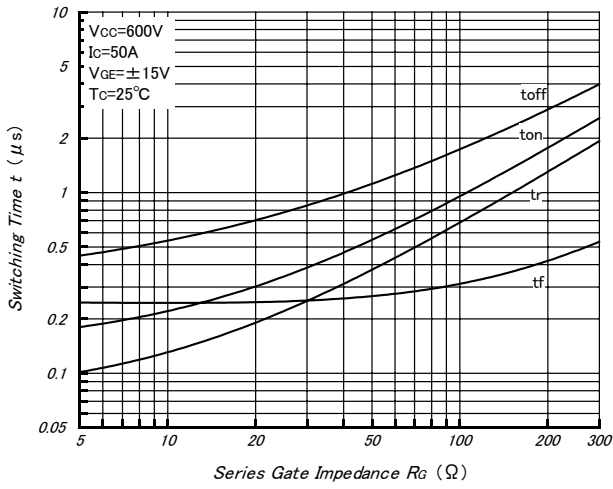


Fig.8- Forward Characteristics of Free Wheeling Diode (Typical)

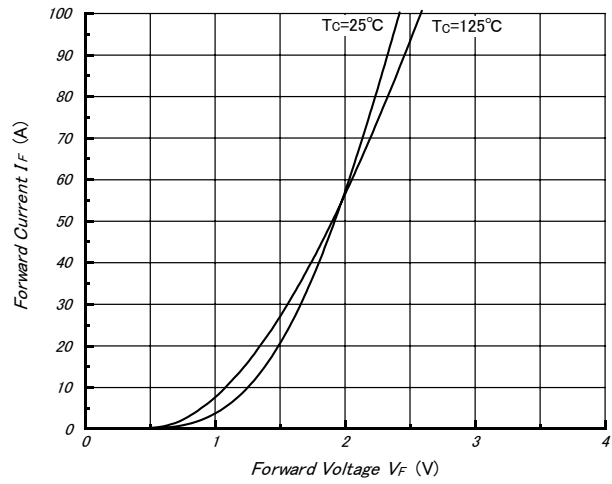


Fig.9- Reverse Recovery Characteristics (Typical)

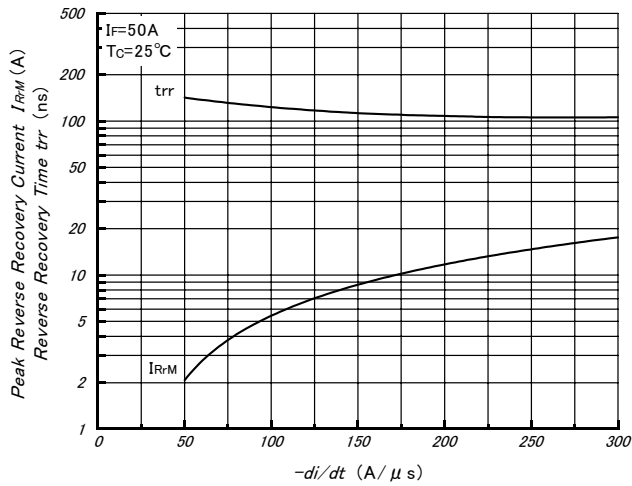


Fig.10- Reverse Bias Safe Operating Area

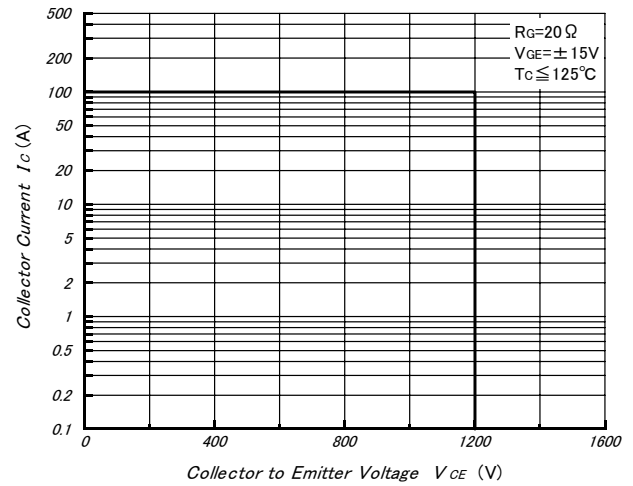


fig11-Tansient Thermal Impedance

